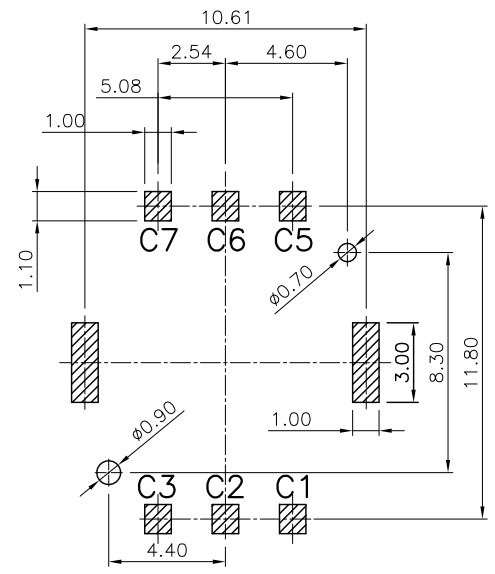
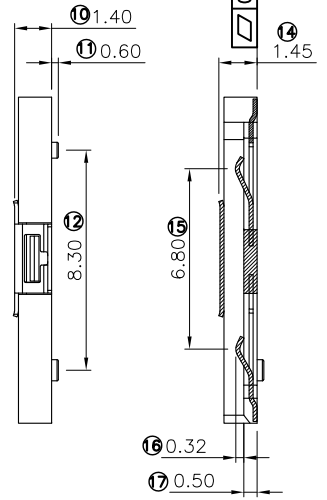
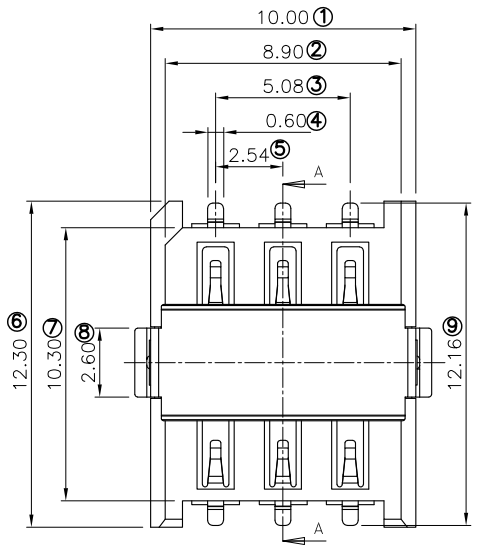


REV.	DESCRIPTION	DATE
A	RELEASE	Dce 10, 2014
B	2016041301	Apr 13, 2016
C	2016102401	Oct 24, 2016



RECOMMEND PCB LAYOUT  
TOLERANCE: ±0.05  
TOP VIEW

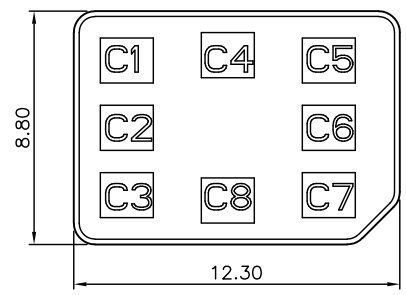
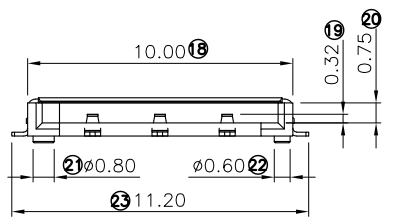
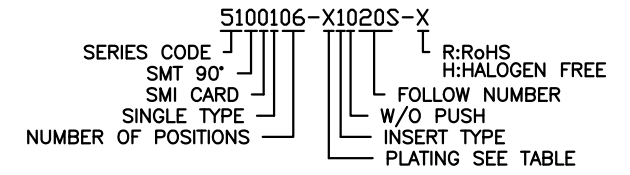
**MATERIALS**

- HOUSING : THERMOPLASTIC (UL 94V-0) .
- TERMINAL : COPPER ALLOY,  
PLATING : GOLD PLATED OVERALL.
- SHELL : SUS.

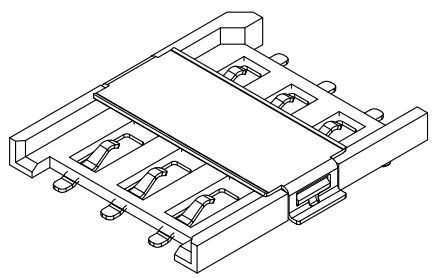
**SPECIFICATION**

- CURRENT RATING : 0.5A AC RMS MAX.
- DIELECTRIC WITHSTANDING VOLTAGE :  
100V AC R.M.S. FOR ONE MINUTE.
- INSULATION RESISTANCE : 1000MΩ MIN. AT 500V DC.
- CONTACT RESISTANCE : 30mΩ MAX.
- OPERATING TEMPERATURE : -20°C TO +85°C.

**PART NUMBER INFORMATION :**



Nano SIM Card



DESCRIPTION OF PLATING ON TERMINALS			
NO.	EXPLAIN	NO.	EXPLAIN
0	GOLD FLASH	3	GOLD 15u"
1	GOLD 5u"	4	GOLD 20u"
2	GOLD 10u"	6	GOLD 30u"

PIN NO.	NAME	TOLERANCE	DRAWER	DRAW NO.
C1	VCC	.0=±0.25	3822U	
C2	RST	.00=±0.15	3822U	
C3	CLK	.000=±0.10	3822U	
C5	GND	ANG.=±3°	3822U	
C6	VPP		PRODUCT SPEC.	
C7	I/O			
		UNITS : mm		
		SCALE NONE	SHEET 1 OF 1	
		SIZE AB	REV. C	

**INMO**  
东莞市英墨电子有限公司  
INMO Electronics Co.,Ltd

NANO SIM SOCKET 6PIN 1.50H